

Product Change Notice

Micron PCN: 31360 Date: 11/11/2014

Type of Change: Manufacturing Site Change

Title of Change:

Assembly site change for Micron SPI NOR Series assembled in DFN 3x4 and DFN

8x6mm packages

Description of Change: Micron NOR SPI series in DFN 3x4 and DFN 8x6mm package assembled today at

Amkor Philippines subcontractor will also be assembled at ASE-Shanghai subcontractor. Customers should be ready to accept these products from either

assembly site.

Reason for Change: Better Align With Industry Standard, Manufacturing Efficiency

Contact Information: Marketing Contact Engineering Contact

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Product Affected: NOR SPI series in DFN 3x4mm and DFN 8x6mm.

Affected Micron Part Number

M25PX64-VME6TG	N25Q032A13EF440E	M25P16-VMC6TG
N25Q008A11EF440E	N25Q032A11EF440E	M25P32-VME6TG
M25PX64-VME6G	N25Q032A11EF440F	M25P64-VME6TG
M25PE40-VMC6G	M25P80-VMC6TG	M25P80-VMC6G
M25PE40-VMC6TG	M25P16-VME6TG	M25P64-VME6G
N25Q008A11EF440F	M25P32-VME6G	M25P40-VMC6GB
N25Q032A13EF440F	M25P16-VME6G	M25P40-VMC6TGB
N25Q032A13EF4A0F	M25P16-VMC6G	

Method of Identification:

Master shipping container Label will indicate country of origin PLH to CHN.

Micron Sites Affected: Subcontractor

Product/Data Schedule

New/Changed Product:

Sample Availability: December 2014

Qual Data Availability: January 2015

Production Shipments: March 2015